

Customer No.: 31561
Application No.: 10/707,139
Docket No.: 10243-US-PA

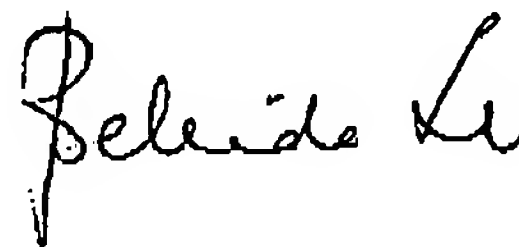
REMARKS

Applicant would like to elect claims 9-23, drawn to a thin film transistor array substrate, classified in class 257, subclass 72. Please cancel claims 1-8, drawn to a method for fabricating a thin film transistor array substrate, classified in class 438, subclass 48 without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date: Nov. 30, 2004

Respectfully submitted,



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